



SANMINA-SCI

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FOR IMMEDIATE RELEASE

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**SANMINA-SCI SUCCESSFULLY DEMONSTRATES SCALABLE 4X BANDWIDTH  
ATCA-COMPATIBLE BACKPLANES**

*Leading EMS Company Extends Useable Bandwidth of ATCA Platform  
from 3.125 Gb/s to 12.5 Gb/s*

**SAN JOSE, Calif. – April 14, 2005** – Sanmina-SCI Corporation (Nasdaq NM: SANM), a leading global electronics manufacturing services (EMS) company, today announced it has successfully demonstrated interoperability of its scalable ATCA (Advanced Telecom Computing Architecture) compatible backplane across a broad spectrum of existing and proposed backplane interconnect standards.

“We have completed testing and collected electrical and performance data that demonstrates how Sanmina-SCI’s suite of design and manufacturing techniques enhances system-level interoperability,” said George Dudnikov, Senior Vice President and Chief Technology Officer for Sanmina-SCI’s PCB Division. “The high-performance market is starting to see some forward momentum, and OEMs are beginning to recognize the performance benefits of using low-distortion interconnects in their systems, which are compatible with drivers and receivers from all major silicon manufacturers. As a result, system designers enjoy a variety of options.”

“Using Sanmina-SCI’s state-of-the-art design and manufacturing capabilities allows us to create interconnects that have reduced loss and distortion characteristics,” explained Franz Gisin, Director of Signal Integrity Design for Sanmina-SCI’s PCB Division. “Sanmina-SCI is at the forefront of this technology and we continue to offer our customers high-technology solutions that increase performance.”

These ATCA-compatible backplanes significantly enhance interoperability performance by equalizing the performance variations seen across major connector technologies (press-fit, SMT, BGA); dielectrics (low-cost and enhanced materials); existing and proposed industry-wide, high-performance interconnect protocols (Ethernet, XAUI, Infiniband®, Fibre Channel, Compact PCT, ATCA, VXI, UXPi); modulation schemes (NRZ, PAM, multi-level signaling); and signal-conditioning schemes (passive and active driver pre-emphasis and receiver equalization).

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### **About Sanmina-SCI**

Sanmina-SCI Corporation is a leading electronics contract manufacturer serving the fastest-growing segments of the global electronics manufacturing services (EMS) market.

Recognized as a technology leader, Sanmina-SCI provides end-to-end manufacturing solutions, delivering unsurpassed quality and support to OEMs primarily in the communications, defense and aerospace, industrial and medical instrumentation, computer technology, and multimedia sectors. Sanmina-SCI has facilities strategically located in key regions throughout the world. More information regarding the Company is available at [www.sanmina-sci.com](http://www.sanmina-sci.com).

### **Sanmina-SCI Safe Harbor Statement**

The foregoing, including the discussion regarding the company's future prospects, contains certain forward-looking statements that involve risks and uncertainties, including uncertainties associated with economic conditions in the electronics industry, particularly in the principal industry sectors served by the company, changes in customer requirements and in the volume of sales to principal customers, the ability of Sanmina-SCI to effectively assimilate acquired businesses and achieve the anticipated benefits of its acquisitions, and competition and technological change. The company's actual results of operations may differ significantly from those contemplated by such forward-looking statements as a result of these and other factors, including factors set forth in the company's fiscal year 2004 Annual Report on Form 10-K filed on December 29, 2004 and 10-Q filed on February 10, 2005 with the Securities Exchange Commission.

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